

Product/process change notification

PCN N° 2022-007-A

Dear customer,

Please find attached our Infineon Technologies AG PCN:

Capacity extension by introduction of 300mm wafer diameter for dedicated OptiMOS™5 products at Infineon Technologies Dresden, Germany for PG-TSDSON-6 packages

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 2022-12-08
- Infineon aligns with the widely recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon to assure a smooth and well-executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.



On 16 April 2020, Infineon acquired Cypress. We are now in the process of merging and consolidating our tools and processes for PCN, Information Notes, Errata and Product Discontinuance. For further details, please visit our website: https://www.infineon.com/cms/en/about-infineon/company/cypress-acquisition/

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 Products affected 	Please refer to attached affected product list 1_cip22007_a						
Detailed change information							
Subject	Introduction of 300mm wafer diameter at Infineon Technologies Dresden GmbH						
Reason	Next phase of Front-End capacity expansion by introduction of 300mm wafer diameter to support continuous increasing customer demand.						
Description	<u>Old</u>	New					
Wafer Production Site & Wafer Test	 Infineon Technologies Austria AG, Villach, Austria (200mm) 	 Infineon Technologies Austria AG, Villach, Austria (200mm) and Infineon Technologies Dresden GmbH, Germany (300mm) 					
Wafer lot number	 VExxxxxx (Villach,200mm) 	 VExxxxxx (Villach,200mm) VFxxxxxx (Villach,300mm) and ZFxxxxxx (Dresden,300mm) 					
 Product identification 	External traceability is assured via wafer lot number & country of diffusion on the product barcode label						
 Impact of change 	 NO change on electrical, thermal parameters and reliability as proven via product qualification and characterization. NO change in existing datasheet parameters NO change in quality and reliability. Processes are optimized to meet product performance according to already applied Infineon specification 						



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 Attachments 	1_cip22007_a	affected product list
► Time schedule		
 Final qualification report 	on request	
 First samples available 	on request	
Intended start of delivery	2022-12-30 or earlie	r based on customer approval

If you have any questions, please do not hesitate to contact your local sales office.

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Affected products sold to DIGI-KEY (4002348)

Sales name	SP number	OPN	Package	Customer part number
IRL100HS121	SP001592836	IRL100HS121	PG-TSDSON-6	IRL100HS121
IRL60HS118	SP001592258	IRL60HS118	PG-TSDSON-6	IRL60HS118
IRL80HS120	SP001592838	IRL80HS120	PG-TSDSON-6	IRL80HS120